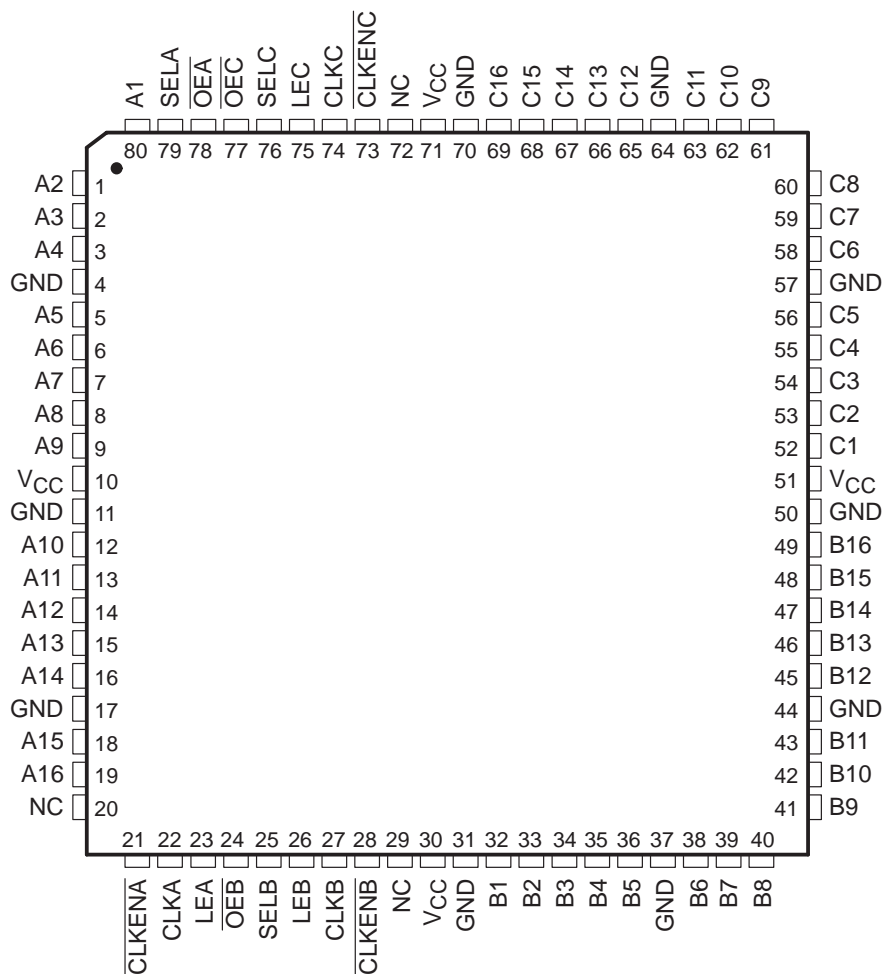


SN54ABTH32316, SN74ABTH32316 16-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

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- Members of the Texas Instruments *Widebus+*™ Family
- State-of-the-Art *EPIC-II B*™ BiCMOS Design Significantly Reduces Power Dissipation
- *UBE*™ (Universal Bus Exchanger) Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, Clocked, or Clock-Enabled Mode
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- High-Impedance State During Power Up and Power Down
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- High-Drive Outputs ($-32\text{-mA } I_{OH}$, $64\text{-mA } I_{OL}$)
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include 80-Pin Plastic Thin Quad Flat (PN) Package With $12 \times 12\text{-mm}$ Body Using 0.5-mm Lead Pitch and 84-Pin Ceramic Quad Flat (HT) Package

'ABTH32316 . . . PN PACKAGE
(TOP VIEW)



NC – No internal connection



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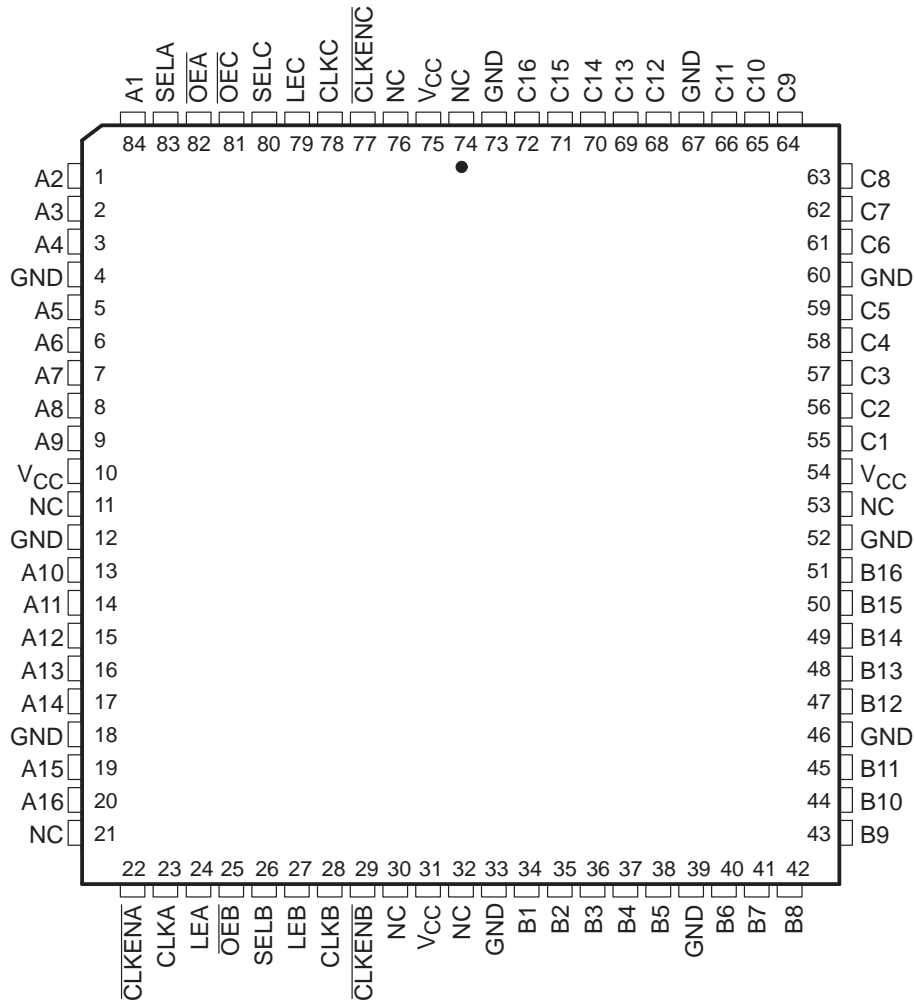
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SN54ABTH32316 . . . HT PACKAGE
(TOP VIEW)



NC – No internal connection

description

The 'ABTH32316 consist of three 16-bit registered input/output (I/O) ports. These registers combine D-type latches and flip-flops to allow data flow in transparent, latch, and clock modes. Data from one input port can be exchanged to one or more of the other ports. Because of the universal storage element, multiple combinations of real-time and stored data can be exchanged among the three ports.

Data flow in each direction is controlled by the output-enable (\overline{OEA} , \overline{OEB} , and \overline{OEC}), select-control (SELA, SELB, and SELC), latch-enable (LEA, LEB, and LEC), and clock (CLKA, CLKB, and CLKC) inputs. The A data register operates in the transparent mode when LEA is high. When LEA is low, data is latched if CLKA is held at a high or low logic level. If LEA and clock-enable A (\overline{CLKENA}) are low, data is stored on the low-to-high transition of CLKA. Output data selection is accomplished by the select-control pins. All three ports have active-low output enables, so when the output-enable input is low, the outputs are active; when the output-enable input is high, the outputs are in the high-impedance state.

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.



description (continued)

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN54ABTH32316 is characterized for operation over the full military temperature range of -55°C to 125°C .
 The SN74ABTH32316 is characterized for operation from -40°C to 85°C .

Function Tables

STORAGE†

| INPUTS | | | | OUTPUT |
|--------|------|-----|---|------------------|
| CLKENA | CLKA | LEA | A | |
| H | X | L | X | Q_0^{\ddagger} |
| L | ↑ | L | L | L |
| L | ↑ | L | H | H |
| X | H | L | X | Q_0^{\ddagger} |
| X | L | L | X | Q_0^{\ddagger} |
| X | X | H | L | L |
| X | X | H | H | H |

† A-port register shown. B and C ports are similar but use $\overline{\text{CLKENB}}$, $\overline{\text{CLKENC}}$, CLKB , CLKC , LEB , and LEC .

‡ Output level before the indicated steady-state input conditions were established

A-PORT OUTPUT

| INPUTS | | OUTPUT A |
|-------------------------|------|----------------------|
| $\overline{\text{OEA}}$ | SELA | |
| H | X | Z |
| L | H | Output of C register |
| L | L | Output of B register |

B-PORT OUTPUT

| INPUTS | | OUTPUT B |
|-------------------------|------|----------------------|
| $\overline{\text{OEB}}$ | SELB | |
| H | X | Z |
| L | H | Output of A register |
| L | L | Output of C register |

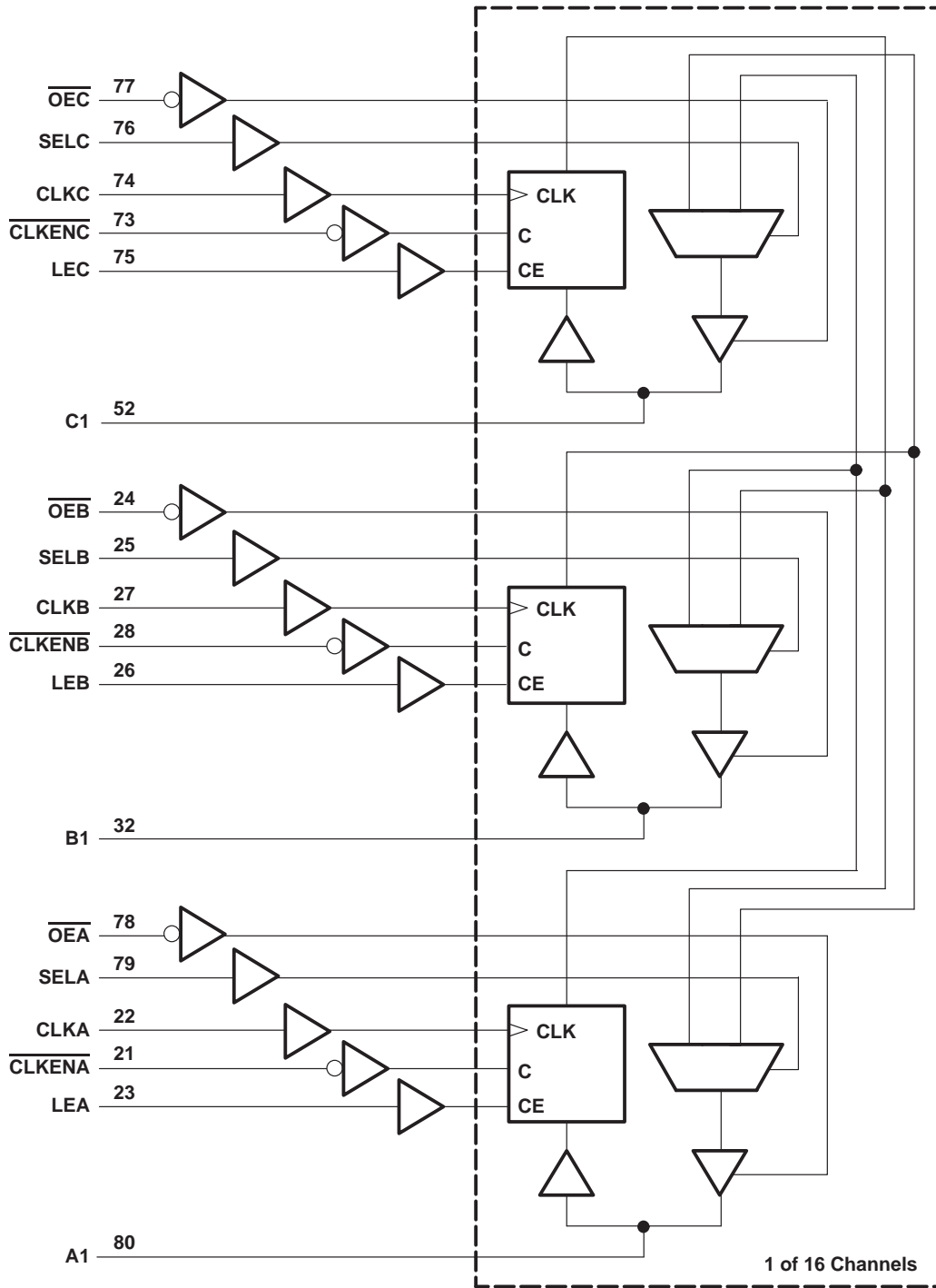
C-PORT OUTPUT

| INPUTS | | OUTPUT C |
|-------------------------|------|----------------------|
| $\overline{\text{OEC}}$ | SELC | |
| H | X | Z |
| L | H | Output of B register |
| L | L | Output of A register |

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logic diagram (positive logic)



Pin numbers shown are for the PN package.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|---|-----------------|
| Supply voltage range, V_{CC} | –0.5 V to 7 V |
| Input voltage range, V_I (except I/O ports) (see Note 1) | –0.5 V to 7 V |
| Voltage range applied to any output in the high or power-off state, V_O | –0.5 V to 5.5 V |
| Current into any output in the low state, I_O : SN54ABTH32316 | 96 mA |
| SN74ABTH32316 | 128 mA |
| Input clamp current, I_{IK} ($V_I < 0$) | –18 mA |
| Output clamp current, I_{OK} ($V_O < 0$) | –50 mA |
| Package thermal impedance, θ_{JA} (see Note 2): PN package | 62°C/W |
| Storage temperature range, T_{stg} | –65°C to 150°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

recommended operating conditions (see Note 3)

| | | SN54ABTH32316 | | SN74ABTH32316 | | UNIT |
|--------------------------|------------------------------------|-----------------|----------|---------------|----------|------|
| | | MIN | MAX | MIN | MAX | |
| V_{CC} | Supply voltage | 4.5 | 5.5 | 4.5 | 5.5 | V |
| V_{IH} | High-level input voltage | 2 | | 2 | | V |
| V_{IL} | Low-level input voltage | | 0.8 | | 0.8 | V |
| V_I | Input voltage | 0 | V_{CC} | 0 | V_{CC} | V |
| I_{OH} | High-level output current | | –24 | | –32 | mA |
| I_{OL} | Low-level output current | | 48 | | 64 | mA |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | Outputs enabled | | 10 | 10 | ns/V |
| $\Delta t/\Delta V_{CC}$ | Power-up ramp rate | 200 | | 200 | | μs/V |
| T_A | Operating free-air temperature | –55 | 125 | –40 | 85 | °C |

NOTE 3: Unused control pins must be held high or low to prevent them from floating.



SN54ABTH32316, SN74ABTH32316 16-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | SN54ABTH32316 | | | SN74ABTH32316 | | | UNIT |
|---------------------------|------------------|--|---------------|------|-----------|---------------|------|-----------|---------------|
| | | | MIN | TYP† | MAX | MIN | TYP† | MAX | |
| V_{IK} | | $V_{CC} = 4.5\text{ V}$, $I_I = -18\text{ mA}$ | | | -1.2 | | | -1.2 | V |
| V_{OH} | | $V_{CC} = 4.5\text{ V}$, $I_{OH} = -3\text{ mA}$ | | | 2.5 | | | 2.5 | V |
| | | $V_{CC} = 5\text{ V}$, $I_{OH} = -3\text{ mA}$ | | | 3 | | | 3 | |
| | | $V_{CC} = 4.5\text{ V}$ | | | 2 | | | 2 | |
| V_{OL} | | $V_{CC} = 4.5\text{ V}$ | | | 0.55 | | | | V |
| | | | | | | | | 0.55 | |
| V_{hys} | | | | | 100 | | | 100 | mV |
| I_I | Control inputs | $V_{CC} = 0\text{ to }5.5\text{ V}$, $V_I = V_{CC}\text{ or GND}$ | | | ± 1 | | | ± 1 | μA |
| | A, B, or C ports | $V_{CC} = 2.1\text{ V to }5.5\text{ V}$, $V_I = V_{CC}\text{ or GND}$ | | | ± 100 | | | ± 20 | |
| $I_I(\text{hold})$ | A, B, or C ports | $V_{CC} = 4.5\text{ V}$ | | | 100 | | | 100 | μA |
| | | | | | -100 | | | -100 | |
| I_{OZPU}^\ddagger | | $V_{CC} = 0\text{ to }2.1\text{ V}$, $V_O = 0.5\text{ V to }2.7\text{ V}$, $\overline{OE} = X$ | | | ± 50 | | | ± 50 | μA |
| I_{OZPD}^\ddagger | | $V_{CC} = 2.1\text{ V to }0$, $V_O = 0.5\text{ V to }2.7\text{ V}$, $\overline{OE} = X$ | | | ± 50 | | | ± 50 | μA |
| I_{off} | | $V_{CC} = 0$, $V_I\text{ or }V_O \leq 4.5\text{ V}$ | | | ± 100 | | | ± 100 | μA |
| I_{CEX} | | $V_{CC} = 5.5\text{ V}$, $V_O = 5.5\text{ V}$ | | | 50 | | | 50 | μA |
| I_O^\S | | $V_{CC} = 5.5\text{ V}$, $V_O = 2.5\text{ V}$ | -50 | -100 | -180 | -50 | -100 | -180 | mA |
| I_{CC} | | $V_{CC} = 5.5\text{ V}$, $I_O = 0$, $V_I = V_{CC}\text{ or GND}$ | | | 2 | | | 2 | mA |
| | | | | 40 | | | 40 | | |
| | | | | 1 | | | 1 | | |
| ΔI_{CC}^\parallel | | $V_{CC} = 5.5\text{ V}$, One input at 3.4 V, Other inputs at $V_{CC}\text{ or GND}$ | | | 1 | | | 0.5 | mA |
| C_i | Control inputs | $V_I = 2.5\text{ V or }0.5\text{ V}$ | | | 3 | | | 3 | pF |
| C_{io} | A, B, or C ports | $V_O = 2.5\text{ V or }0.5\text{ V}$ | | | 11.5 | | | 11.5 | pF |

† All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

‡ This parameter is specified by characterization.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

| | | | SN54ABTH32316 | | SN74ABTH32316 | | UNIT |
|-------------|-----------------|----------------------------------|---------------|-----|---------------|-----|------|
| | | | MIN | MAX | MIN | MAX | |
| f_{clock} | Clock frequency | | 0 | 150 | 0 | 150 | MHz |
| t_w | Pulse duration | LE high | 3.3 | | 3.3 | | ns |
| | | CLK high or low | 3.3 | | 3.3 | | |
| t_{su} | Setup time | A, B, or C before CLK \uparrow | 2.6 | | 2.4 | | ns |
| | | A or B before LE \downarrow | 2.5 | | 2.1 | | |
| | | CLKEN before CLK \uparrow | 3.5 | | 3.2 | | |
| t_h | Hold time | A, B, or C after CLK \uparrow | 1.8 | | 1.4 | | ns |
| | | A or B after LE \downarrow | 2.4 | | 2.1 | | |
| | | CLKEN after CLK \uparrow | 1.5 | | 1.1 | | |



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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | SN54ABTH32316 | | SN74ABTH32316 | | UNIT |
|-----------|-----------------|----------------|---------------|-----|---------------|-----|------|
| | | | MIN | MAX | MIN | MAX | |
| f_{max} | | | 150 | | 150 | | MHz |
| t_{PLH} | A, B, or C | C, B, or A | 0.8 | 6.5 | 1.4 | 6.1 | ns |
| t_{PHL} | | | 0.5 | 6.8 | 1.1 | 6.6 | |
| t_{PLH} | SEL | A, B, or C | 0.8 | 6.7 | 1.4 | 6.5 | ns |
| t_{PHL} | | | 0.8 | 6.8 | 1.8 | 6.5 | |
| t_{PLH} | LE | A, B, or C | 1.5 | 8 | 2.6 | 7.5 | ns |
| t_{PHL} | | | 1.5 | 7.4 | 2.6 | 6.9 | |
| t_{PLH} | CLK | A, B, or C | 1.5 | 8 | 2.5 | 7.5 | ns |
| t_{PHL} | | | 1.5 | 7.2 | 2.5 | 6.7 | |
| t_{PZH} | \overline{OE} | A, B, or C | 0.8 | 6.7 | 1.5 | 6.4 | ns |
| t_{PZL} | | | 1.5 | 7.1 | 2.4 | 6.8 | |
| t_{PHZ} | \overline{OE} | A, B, or C | 0.8 | 7.2 | 1.5 | 6 | ns |
| t_{PLZ} | | | 0.8 | 6.4 | 1.9 | 6.1 | |

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PARAMETER MEASUREMENT INFORMATION

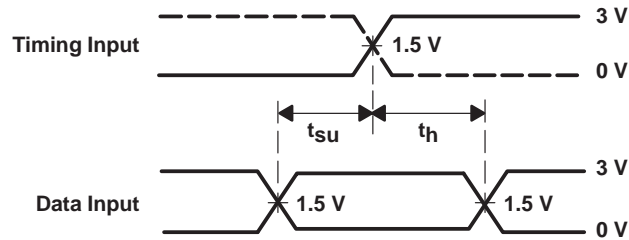


LOAD CIRCUIT

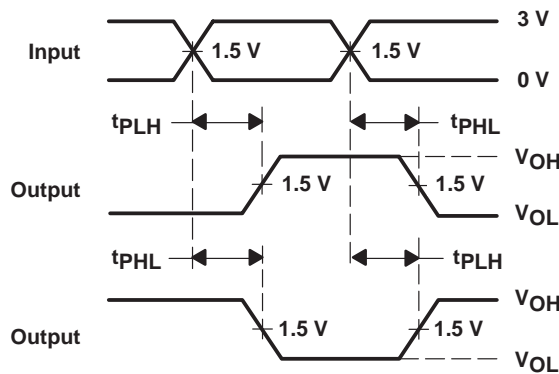
| TEST | S1 |
|-------------------|------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | 7 V |
| t_{PHZ}/t_{PZH} | Open |



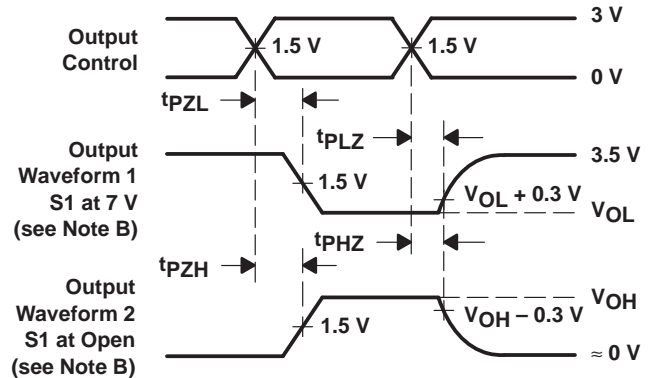
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS






VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|----------------------------|-------------------------|----------------------|--------------|---|---|
| 5962-9680801QXA | ACTIVE | CFP | HT | 84 | 250 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | 5962-9680801QX A SNJ54ABTH32316 HT |  |
| SN74ABTH32316PN | ACTIVE | LQFP | PN | 80 | 119 | Green (RoHS & no Sb/Br) | NIPDAU | Level-3-260C-168 HR | -40 to 85 | ABTH32316 |  |
| SNJ54ABTH32316HT | ACTIVE | CFP | HT | 84 | 250 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | 5962-9680801QX A SNJ54ABTH32316 HT |  |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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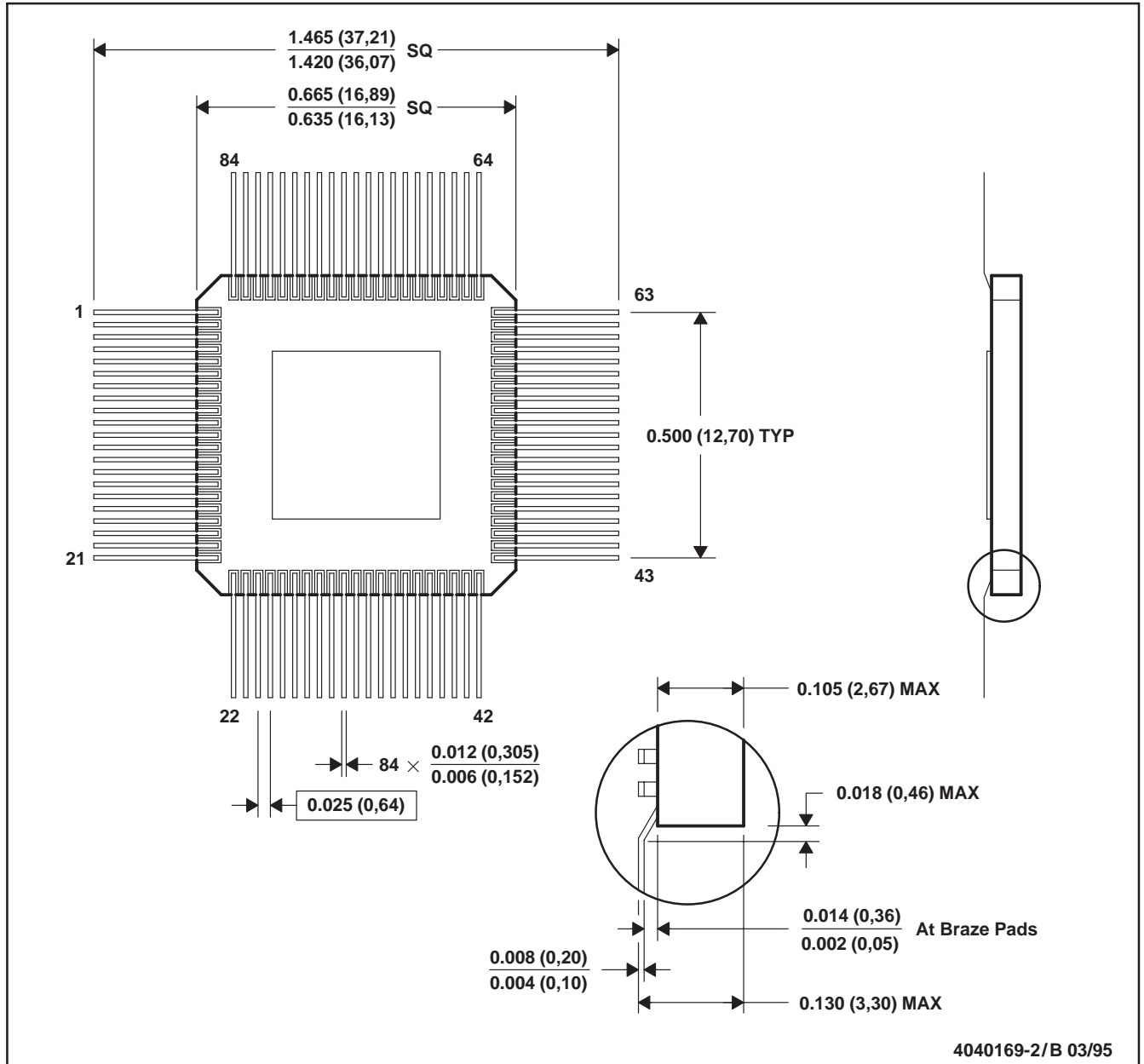
- Catalog: [SN74ABTH32316](#)
- Military: [SN54ABTH32316](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

HT (S-CQFP-F84)

CERAMIC QUAD FLATPACK



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a metal lid.
 - D. The terminals are gold plated.
 - E. Falls within JEDEC MO-090 AA

PN (S-PQFP-G80)

PLASTIC QUAD FLATPACK



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Falls within JEDEC MS-026

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